

FQPF17N08L

80V LOGIC N-Channel MOSFET

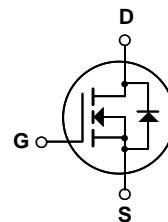
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, high efficiency switching for DC/DC converters, and DC motor control.

Features

- 11.2A, 80V, $R_{DS(on)} = 0.1\Omega$ @ $V_{GS} = 10\text{ V}$
- Low gate charge (typical 8.8 nC)
- Low C_{RSS} (typical 29 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating
- Low level gate drive requirements allowing direct operation from logic drives



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	FQPF17N08L	Units
V_{DSS}	Drain-Source Voltage	80	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	11.2	A
	- Continuous ($T_C = 100^\circ\text{C}$)	7.9	A
I_{DM}	Drain Current - Pulsed	(Note 1)	A
V_{GSS}	Gate-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	mJ
I_{AR}	Avalanche Current	(Note 1)	A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	30	W
	- Derate above 25°C	0.2	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	°C
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C

Thermal Characteristics

Symbol	Parameter	Typ	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	--	5.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	62.5	°C/W

Electrical Characteristics

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	80	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C	--	0.08	--	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}$, $V_{GS} = 0 \text{ V}$	--	--	1	μA
		$V_{DS} = 64 \text{ V}$, $T_C = 150^\circ\text{C}$	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	-100	nA

On Characteristics

$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	1.0	--	2.0	V
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$, $I_D = 5.6 \text{ A}$ $V_{GS} = 5 \text{ V}$, $I_D = 5.6 \text{ A}$	--	0.076 0.090	0.100 0.115	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 25 \text{ V}$, $I_D = 5.6 \text{ A}$ (Note 4)	--	11.4	--	S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}$, $V_{GS} = 0 \text{ V}$,	--	400	520	pF
C_{oss}	Output Capacitance	$f = 1.0 \text{ MHz}$	--	120	155	pF
C_{rss}	Reverse Transfer Capacitance		--	29	37	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 40 \text{ V}$, $I_D = 16.5 \text{ A}$, $R_G = 25 \Omega$	--	7	25	ns
t_r	Turn-On Rise Time		--	290	590	ns
$t_{d(off)}$	Turn-Off Delay Time		--	20	50	ns
t_f	Turn-Off Fall Time		--	75	160	ns
Q_g	Total Gate Charge	$V_{DS} = 64 \text{ V}$, $I_D = 16.5 \text{ A}$, $V_{GS} = 5 \text{ V}$	--	8.8	11.5	nC
Q_{gs}	Gate-Source Charge		--	2.0	--	nC
Q_{gd}	Gate-Drain Charge		--	5.4	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I_S	Maximum Continuous Drain-Source Diode Forward Current	--	--	11.2	A	
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	44.8	A	
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}$, $I_S = 11.2 \text{ A}$	--	--	1.5	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}$, $I_S = 16.5 \text{ A}$, $dI_F / dt = 100 \text{ A}/\mu\text{s}$	--	55	--	ns
Q_{rr}	Reverse Recovery Charge		--	85	--	nC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L = 1.1\text{mH}$, $I_{AS} = 11.2\text{A}$, $V_{DD} = 25\text{V}$, $R_G = 25 \Omega$. Starting $T_J = 25^\circ\text{C}$
3. $I_{SD} \leq 16.5\text{A}$, $dI/dt \leq 300\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$. Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature

Typical Characteristics

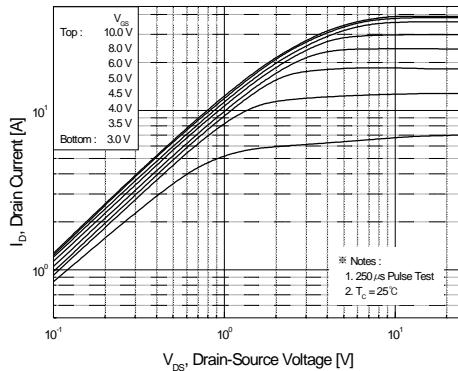


Figure 1. On-Region Characteristics

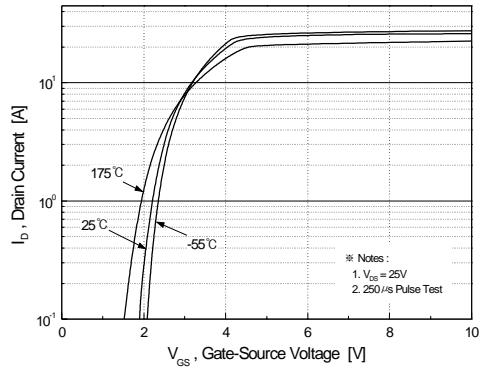
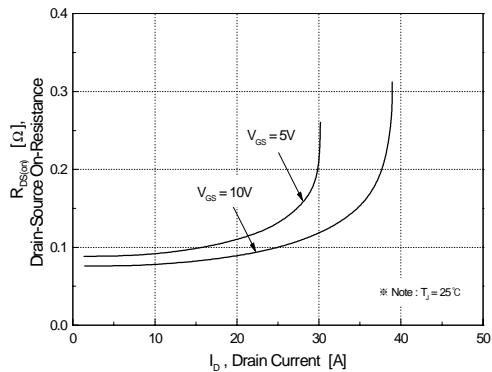
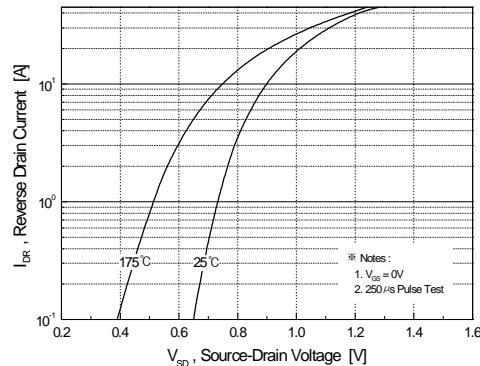


Figure 2. Transfer Characteristics



**Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage
Variation vs. Source Current
and Temperature**

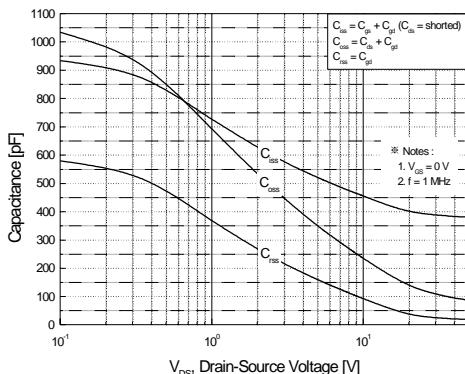


Figure 5. Capacitance Characteristics

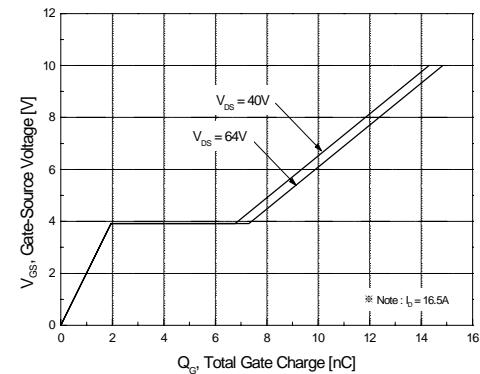


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

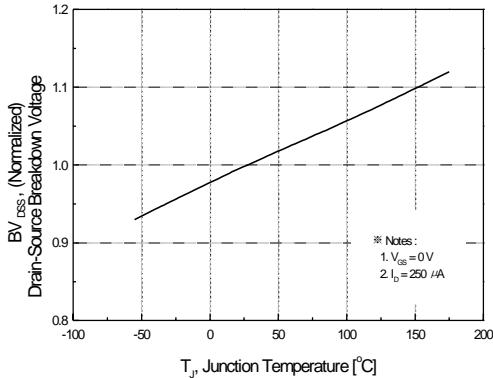


Figure 7. Breakdown Voltage Variation vs. Temperature

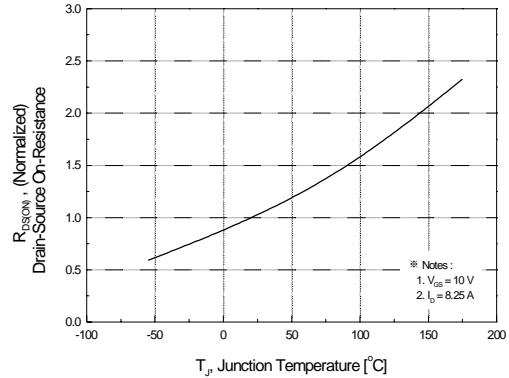


Figure 8. On-Resistance Variation vs. Temperature

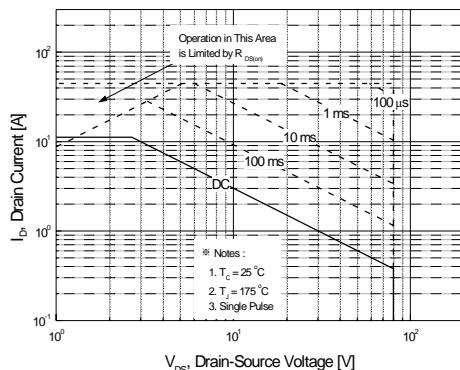


Figure 9. Maximum Safe Operating Area

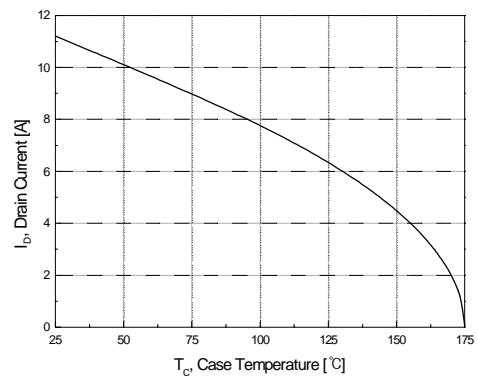


Figure 10. Maximum Drain Current vs. Case Temperature

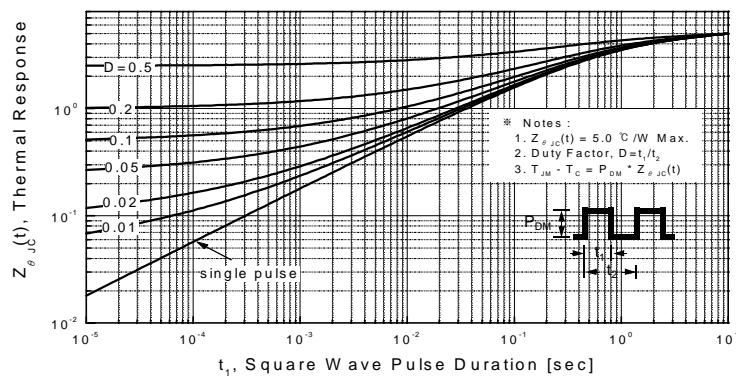
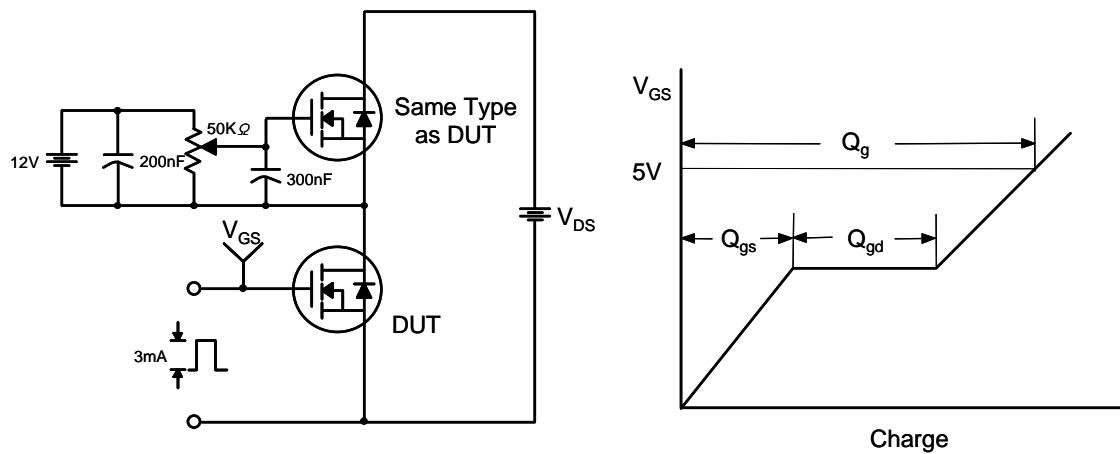
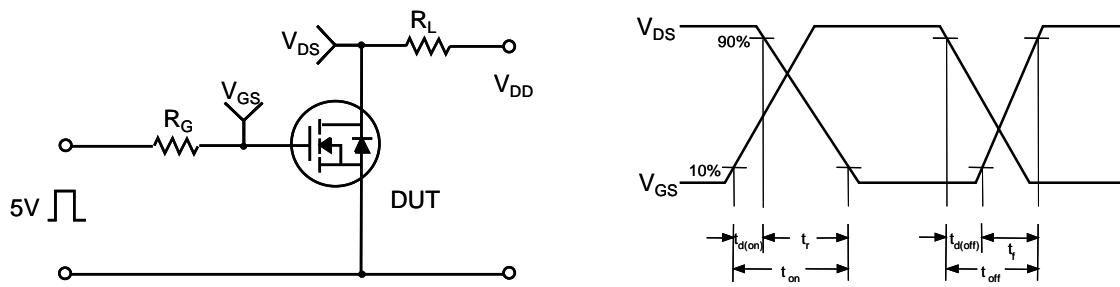
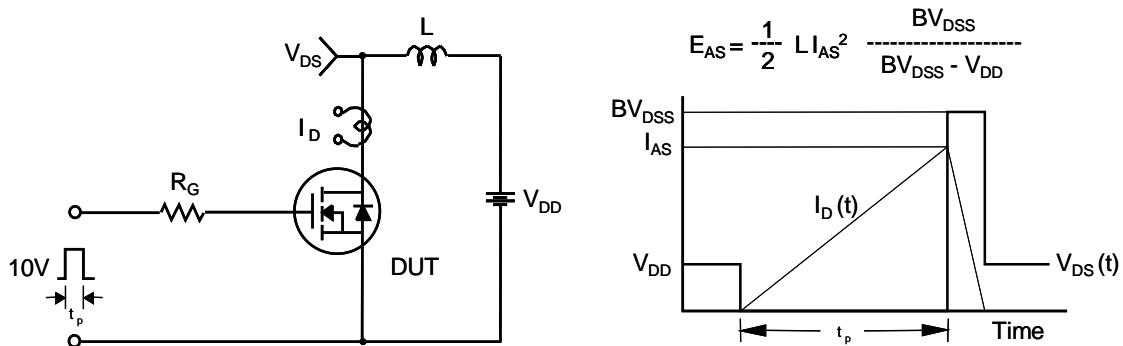
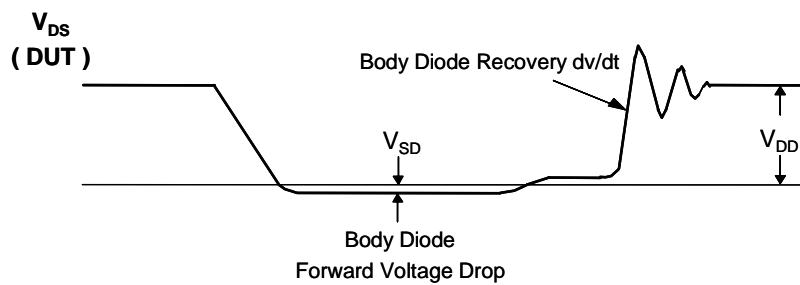
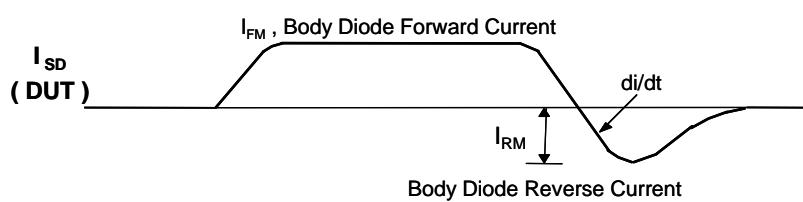
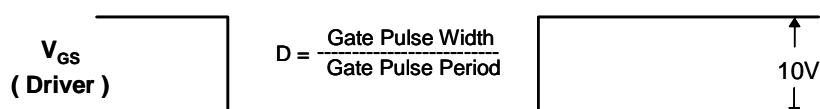
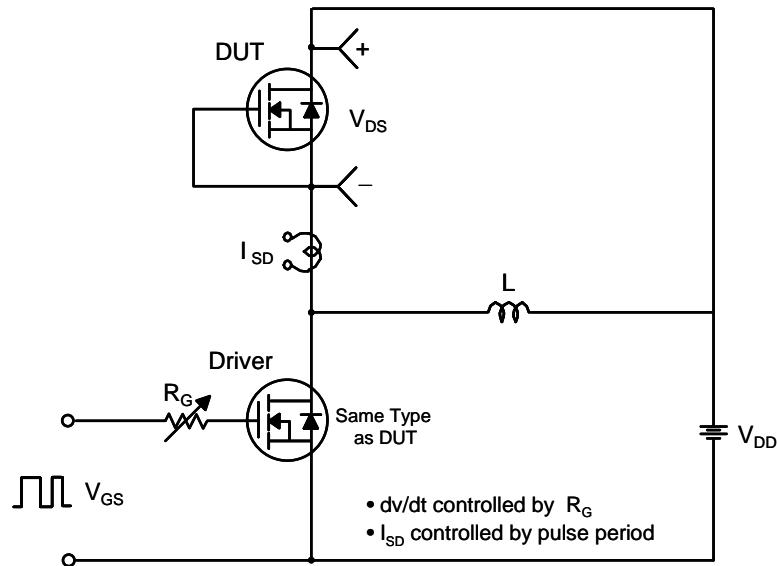


Figure 11. Transient Thermal Response Curve

Gate Charge Test Circuit & Waveform**Resistive Switching Test Circuit & Waveforms****Unclamped Inductive Switching Test Circuit & Waveforms**

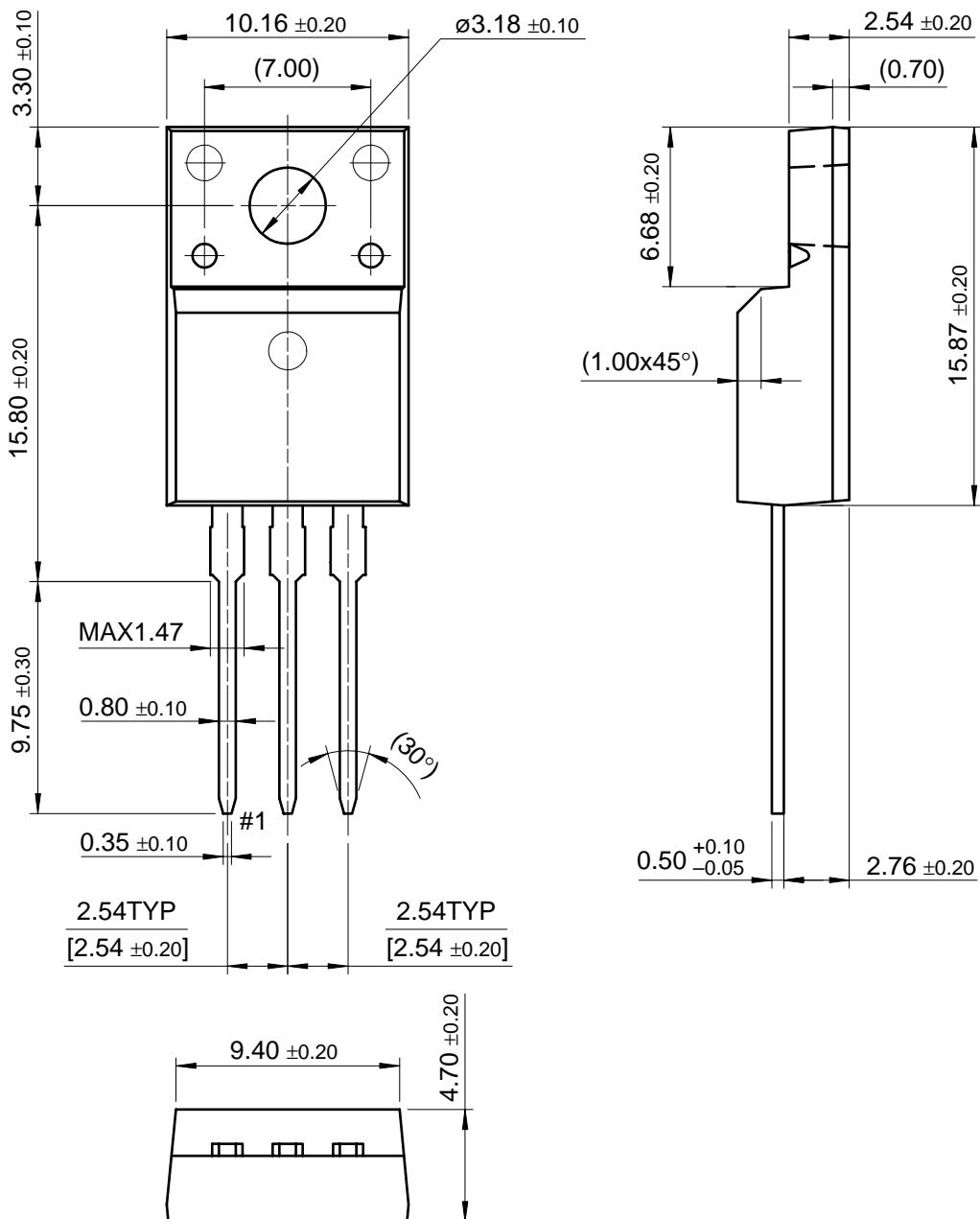
Peak Diode Recovery dv/dt Test Circuit & Waveforms



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Package Dimensions

TO-220F



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